

RA2A2 Group

Board Control Program for QE for AFE

Introduction

The control program operates on RA2A2 on the Evaluation Kit for RA2A2E (EK-RA2A2), communicates commands with the AFE development support tool 'QE for AFE', and can set registers for analog IP and obtain the A/D conversion values as shown below.

- 24-Bit Sigma-Delta A/D Converter (SDADC24) Hi-Speed USB-UART conversion adapter enables continuous Measurement with the following high-speed sampling settings.
 - 7 channels setting and 8kHz sampling setting
 - 4 channels setting and 8kHz/4kHz Hybrid sampling setting
- 12-Bit A/D Converter (ADC12)

Hi-Speed USB-UART conversion adapter enables continuous measurement with the following high-speed sampling settings.

- 1 channel setting and sampling time setting of 7us or more
- 2 or more channels setting and sampling time setting of 5us or more

Target Device

RA2A2 (R7FA2A2AD3CFP)

Board to Be Operated

EK-RA2A2 Evaluation Kit for RA2A2 Microcontroller Group

Available Communication I/F:

- SCI UART Communication: A separate USB-UART conversion adapter is required.
 - Hi-Speed 12Mbps:

USB 2.0 Hi-Speed to UART Cable C232HD- EDHSP-0 manufactured by Future Technology Devices International (FTDI)

(Hereafter abbreviated as Hi-Speed 12Mbps USB-UART conversion adapter)

3Mbps:

PmodTM I/F: d FTD, PmodTM USBUART manufactured by FTDI

mikroBUS[™] I/F: USB UART click (MIKROE-1203) manufactured by MikroElektronika (Hereinafter, both are abbreviated as 3Mbps USB-UART conversion adapter)

The SDADC24/ADC12 are capable of high-data rate output, so when using "SDADC24 Continuous Measurement" and "ADC12 Continuous Measurement", set the connection Bitrate to 3 Mbps or higher.

For details, refer to "Table 1-7 SDADC24: Sampling Mode, Number of Channels and Supported Bitrate when Using UART" and "Table 1-5 ADC12 Continuous Measurement Operation Conditions when Using SCI UART".



Contents

| 1. Overview | 4 |
|--|----|
| 1.1 System Overview | 4 |
| 1.1.1 About the Included HEX Files and e2 studio Projects | 5 |
| 1.2 Measured Value Transmission Operation during A/D Conversion | 7 |
| 1.2.1 When Using SCI UART | 7 |
| 1.3 Precautions on Use | 10 |
| 1.4 Feature Updates History | 10 |
| 1.5 File Configurations | 11 |
| 1.6 Operation Confirmation Environment | 12 |
| 1.7 Related Documentation | 12 |
| 2. How to Use | 13 |
| 2.1 How to Write FW | 13 |
| 2.1.1 Writing using Renesas Flash Programmer | 13 |
| 2.2 Run Project | 16 |
| 2.2.1 Connecting to PC | 16 |
| 2.2.2 Launch QE for AFE | 20 |
| 2.2.2.1 Preparation | 20 |
| 2.2.2.2 Launching QE for AFE and Connecting to Target Board | 20 |
| 2.2.2.3 Message at Time of Completion of QE for AFE Continuous Measurement and Measurement Tin | ne |
| | 21 |
| 3. Program Description | 22 |
| 3.1 Overview | 22 |
| 3.2 Peripherals to Use and Pin Settings | 22 |
| 3.2.1 Peripherals to Use | 22 |
| 3.2.2 Pin Settings | 23 |
| 3.2.2.1 Pin List | 23 |
| 3.2.3 How LED Work | 26 |
| 3.3 Communication Specifications | 27 |
| 3.3.1 UART Serial Communication Settings | 27 |
| 3.4 Write and Build Using e2 studio Integrated Development Environment (IDE) | 28 |
| 3.4.1 Import Procedure | 28 |
| 3.4.2 Launch Debug Mode | 28 |
| 3.4.3 Notes on Building e2 Studio Projects | 29 |
| 3.4.4 Stack Size | 29 |
| 3.4.5 About e2 studio Project Source Changes | 30 |
| 4. Trouble-solving Method | 31 |
| Revision History | 33 |



Trademarks

Arduino® is the registered trademark of Arduino SA.

J-LINK[®] is the registered trademarks of SEGGER MICROCONTROLLER GMBH & CO. KG.

mikroBUS™ is the trademarks of MIKROELEKTRONIKA DOO BEOGRAD ZEMUN.

Pmod[™] and PmodUSBUART[™] are the trademarks of Digilent Inc.

Other brands and names mentioned in this document may be the trademarks or registered trademarks of their respective holders.



1. Overview

This control program is intended to be used in combination with 'QE for AFE'.

Therefore, refer to the 'QE for AFE' document and use this control program.

1.1 System Overview

This control program (hereinafter abbreviated as 'FW') operates on RA2A2 on the EK-RA2A2.

You can communicate using 'QE for AFE' via SCI UART and control the following according to the command request from 'QE for AFE':

- Register Settings for 24-Bit Sigma-Delta A/D Converter (SDADC24)
- Register Settings for 12-Bit A/D Converter (ADC12)

The differences in specifications/functions of the provided projects and HEX files settings are shown below. Select the connection method according to your purpose.

For the specific connection method, refer to '2.2.1 Connecting to PC'.

Table 1-1 Connection Method and Differences in Specifications/Functions

| Items | | SCI UART | |
|--------------------------------|--|------------------------|---------------------|
| Main Clock | | HOCO 64MHz HOCOC 48MHz | |
| ICLK Freque | ncy (max.) | 32MHz: divided HOCO | 48MHz: divided HOCO |
| PCLKB Freq | uency (max.) | 32MHz: divided HOCO | 24MHz: divided HOCO |
| PCLKD(=ADCLK) Frequency (max.) | | 32MHz: divided HOCO | 24MHz: divided HOCO |
| ADC12 | ADCLK Frequency (max.) | 32MHz [Note 2] | 24MHz |
| | Continuous Measurement of A/D conversion [Note 1] | Support under s | pecific conditions |
| | One-shot Measurement of A/D conversion [Note 1] | Supp | oorted |
| SDADC24 | Continuous Measurement of A/D Conversion [Note 1] | Supp | oorted |

Note 1: For details, refer to '1.2 Measured Value Transmission Operation during A/D Conversion' Note 2: For EK-RA2A2, because AVCC = 3.3V.



1.1.1 About the Included HEX Files and e2 studio Projects

The overview of the included HEX files and the e2 studio projects are shown below.

(1) HEX Files

Evaluation is possible by writing the HEX file to EK-RA2A2.

For the FW writing method, refer to '2.1.1 Writing using Renesas Flash Programmer'.

Also, refer to '1.6 Operation Confirmation Environment' for the settings when creating a HEX file.

For information on the port assignments, refer to 'Table 3-2 Pins used List'.

Table 1-2 HEX Files

| HEX Files | | | Destination |
|-----------|-------|------------------------------|--|
| UART0 | RTS/0 | CTS flow control [Note 1] | Hex |
| | • | PCLKB frequency: 32MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 32MHz | └──ek_ra2a2_uart0_32MHz_rev230.hex |
| | Witho | ut RTS/CTS flow control | Hex |
| | [Note | 2] | └──ek_ra2a2 |
| | For m | ikroBUS | └──ek_ra2a2_uart0nohwflow_32MHz_rev230.hex |
| | • | PCLKB frequency: 32MHz | |
| | • | PCLKD frequency: 32MHz | |
| | RTS/0 | CTS flow control [Note 5, 8] | Hex |
| | • | PCLKB frequency: 16MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 16MHz | └──ek_ra2a2_uart0_16MHz_rev230.hex |
| | RTS/0 | CTS flow control [Note 3] | Hex |
| | • | PCLKB frequency: 24MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 24MHz | └──ek_ra2a2_uart0_24MHz_rev230.hex |
| | RTS/0 | CTS flow control [Note 4, 8] | Hex |
| | • | PCLKB frequency: 12MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 12MHz | └──ek_ra2a2_uart0_12MHz_rev230.hex |
| UART3 | RTS/0 | CTS flow control [Note 6] | Hex |
| | • | PCLKB frequency: 32MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 32MHz | ek_ra2a2_uart3_32MHz_rev230.hex |
| | RTS/0 | CTS flow control [Note 7, 8] | Hex |
| | • | PCLKB frequency: 16MHz | └──ek_ra2a2 |
| | • | PCLKD frequency: 16MHz | └──ek_ra2a2_uart3_16MHz_rev230.hex |

Note 1: This is the same setting as "ek_ra2a2_uart0_32MHz" in "Table 1-3 e2 studio Projects".

Note 2: This is the same setting as "ek_ra2a2_uart0nohwflow_32MHz" in "Table 1-3 e2 studio Projects". Note 3: This is the same setting as "ek_ra2a2_uart0_24MHz" in "Table 1-3 e2 studio Projects".

- Note 4: This is a setting in which the clock frequency is changed based on "ek_ra2a2_uart0_24MHz" in "Table 1-3 e2 studio Projects"..
- Note 5: This is a setting in which the clock frequency is changed based on "ek_ra2a2_uart0_32MHz" in "Table 1-3 e2 studio Projects"..
- Note 6: This is the same setting as "ek_ra2a2_uart3_32MHz" in "Table 1-3 e2 studio Projects".
- Note 7: This is a setting in which the clock frequency is changed based on "ek_ra2a2_uart3_32MHz" in "Table 1-3 e2 studio Projects"..
- Note 8: This is the Hex file for ADC12 continuous measurement. For details, see "1.2 Measured Value Transmission Operation during A/D Conversion".



(2) e2 studio Projects

Evaluation is possible by importing the e2 studio project and writing it to EK-RA2A2.

It is provided with the setting to be automatically executed when the '**Build'** is executed, is pressed, and the '**Debug'** mode is launched.

For the FW writing method, refer to '3.4 Write and Build Using e2 studio Integrated Development Environment (IDE)'.

Also, refer to '1.6 Operation Confirmation Environment' for the settings when creating a HEX file.

For information on the port assignments, refer to 'Table 3-2 Pins used List'.

Note that HEX files of 'Table 1-2 HEX Files' were created using the following projects or the clock frequency was changed.

Table 1-3 e2 studio Projects

| I/F | e2 studio Project | Destination |
|-------|--|---------------------------------|
| UART0 | RTS/CTS flow control | ek_ra2a2 |
| | PCLKB frequency: 32MHz | └──ek_ra2a2_uart0_32MHz |
| | PCLKD frequency: 32MHz | |
| | Without RTS/CTS flow control | ek_ra2a2 |
| | For mikroBUS | └──ek_ra2a2_uart0nohwflow_32MHz |
| | PCLKB frequency: 32MHz | |
| | PCLKD frequency: 32MHz | |
| | RTS/CTS flow control | ek_ra2a2 |
| | PCLKB frequency: 24MHz | └──ek_ra2a2_uart0_24MHz |
| | PCLKD frequency: 24MHz | |
| UART3 | RTS/CTS flow control | ek_ra2a2 |
| | PCLKB frequency: 32MHz | └──ek_ra2a2_uart3_32MHz |
| | PCLKD frequency: 32MHz | |



1.2 Measured Value Transmission Operation during A/D Conversion

During A/D conversion, the measured values are sent to the PC for Continuous measurement. This measurement is defined as **'Continuous measurement'**.

When using ADC12 (Analog Input Pins), which is capable of high output data rate, the transmission process may not be in time. In that case, after acquiring the specified number of A/D values, A/D conversion is stopped and the acquired A/D values are sent together. This measurement is defined as **'One-shot measurement'**.

1.2.1 When Using SCI UART

The following shows the measurement operation for each measurement target.

Table 1-4 Measurement Operation of SDADC24, ADC12, ACMPHS, ACMPLP when Using USB PCDC

| Measurement Target | Measurement Operation |
|------------------------------------|---|
| SDADC24 | Supports Continuous measurement only. |
| | Refer to 1.2.1(2) SDADC24. |
| ADC12 (Analog Input Pins) | Switches to Continuous measurement or One-shot |
| | measurement depending on operating conditions. [Note 1] |
| ADC12 (Temperature Sensor Output) | Supports Single measurement with single scan |
| ADC12 (Internal Reference Voltage) | |

Note 1: Refer to 'Table 1-5 ADC12 Continuous Measurement Operation Conditions when Using SCI UART'.

(1) ADC12

Switching between **Continuous measurement** and **One-shot measurement** operating conditions and precautions are indicated.

(a) ADC12 Continuous Measurement

The following shows the Continuous measurement operating conditions of ADC12 when using SCI UART.

Depending on the settings of PCLKB frequency = PCLKD frequency, sampling time and number of channels, the FW switches between continuous measurement or one-shot measurement.

These settings do not guarantee the continuous measurement operation.



| System Clock | Comm unicat ion I/F | ICLK Freq. | PCLKB Freq. = PCLKD Freq. | Sampling Time -Upper: Single channel -Lower: Multiple channels -Value in (): ADSSTR value [Note 1] | UART Bitrate Setting [bps] | QE for AFE Measurement Time (Sampling Time Dependence) | Remarks |
|-----------------|---------------------------|---------------|---------------------------------------|--|-------------------------------------|--|----------|
| HOCO 48MHz | UART | 48MHz | 24MHz | 7us (168) or more 5us (120) or more | 4,000,000 | Shown for each average value | |
| | | | | 7.5us (180) or more 7us (168) or more | 3,000,000 | of sampling time. | |
| | | | 12MHz | 10us (120) or more 10us (120) or more | 2,000,000 | -5us: About 5 min. | [Note 3] |
| HOCO 64MHz | | 32MHz | 32MHz | 7us (224) or more 5us (160) or more | 5,333,333 | -7us: About 7 min. | |
| | | | | 7.5us (240) or more 7us (224) or more | 3,000,000 | -7.5us: About 7.5 min. | |
| | | | 16MHz | 7.5us (120) or more 7.5us (120) or more | 2,666,666 | -10us: About 10 min. | [Note 4] |

Table 1-5 ADC12 Continuous Measurement Operation Conditions when Using SCI UART

Note 1: The time is an estimate. It is judged by the ADSSTR value.

The total ADSSTR value of the set channels is compared with the number of channels x ADSSTR value.

Note 2: If a value less than the specified value is set, the transmission will not be in time and measurement will not be possible.

Note 3: It is the setting of the HEX file 'ek_ra2a2-uart0-12MHz-rev230.hex' shown in "Table 1-2 HEX Files". Note 4: It is the setting of the HEX file 'ek ra2a2-uart0-16MHz-rev230.hex' shown in "Table 1-2 HEX Files".

In addition, QE for AFE may miss data depending on PC environment during the Continuous measurement operation. In that case, the following error will be displayed on QE for AFE.

[Error]Some data missed in communication. Please check missing data in [Raw Data] view.

Figure 1-1 Error Message when Data Is Missed

Therefore, please evaluate it when other applications are stopped or network offline. If data is still missing, increase the ADSSTR value and lower the output data rate.

(b) ADC12 One-Shot Measurement

The number of measured values and the time of measurement that can be acquired in the case of One-shot measurement settings are shown below.

| Table 1-6 | Number of | Storable Me | easured and | I Measurement | Time for | ADC12 | One-shot | Measurement |
|-----------|-----------|-------------|-------------|---------------|----------|-------|----------|-------------|
|-----------|-----------|-------------|-------------|---------------|----------|-------|----------|-------------|

| Items | Contents |
|---------------------------|---|
| Number of measured values | 8,192 (Max.) |
| for One-shot measurement | Number of Measured Values of Each Channel |
| | = 8,192/(Number of measurement channels); (Rounded down) |
| Measurement Time of One- | Sum of [(Number of Measured Values of Each Channel) x (sampling |
| shot measurement | time of each channel)] |

When combined with QE for AFE, intermittent measurement [Auto] that repeats One-shot measurement is possible.

Note that in the case of this measurement, the start and end of measurement are repeated, so the start of the measurement after the end of the measurement and the start of the next measurement is not continuous data because there is a gap in the measurement time.



(2) SDADC24

The operating conditions and precautions for continuous measurement are indicated.

(a) SDADC24 Continuous Measurement

The SDADC24 is capable of high-output data rate output. Therefore, a high Bitrate setting of the UART is required to achieve continuous measurement operation.

The following shows the relationship between the sampling mode, the number of channels, and the UART Bitrate. These settings do not guarantee the continuous measurement operation.

Select a USB-UART conversion adapter and set the maximum possible Bitrate according to the SDADC24 measurement conditions.

| Sampling Mode | Number of | Connection B | itrate [bps] [No | Remarks | |
|---------------|-----------|---------------|------------------|-----------|---|
| | Channels | 3M | 4M | 5.333333M |] |
| 4kHz | 1 to 4 | Available | Available | Available | |
| 8kHz | 1 to 4 | | | | |
| | 5 | Not Available |] | | |
| | 6 | | Not Available | | |
| | 7 | | | | |
| 8kHz/4kHz | 1 to 2 | Available | Available | | |
| Hybrid | 3 | Available | | | |
| | | [Note 3] | | | |
| | 4 | Not Available | Available | | |
| | | | [Note 2] | | |

Table 1-7 SDADC24: Sampling Mode, Number of Channels and Supported Bitrate when Using UART

Note 1: For details on the USB-UART conversion adapter, refer to 'Table 1-10 Operating Confirmation Conditions' and 'Table 1-11 Clock Settings and Tools to Use (SCI UART)'.

Use a bitrate of 3Mbps or higher.

For Bitrate, refer to 'Table 3-3 Serial Communication Settings'.

Note 2: If no data is output on the GUI, reduce the number of measurement channels.

Note 3: It depends on the FW you use.

ek_ra2a2_uart0_32MHz_rev230.hex: Not available

ek_ra2a2_uart0_24MHz_rev230.hex: Available. If no data is output on the GUI, reduce the number of measurement channels.

Note that during continuous measurement operation, there is a possibility that QE for AFE may miss data depending on the PC environment. In this case, the following error is displayed on QE for AFE:

[Error]Some data missed in communication. Please check missing data in [Raw Data] view.

Figure 1-2 Error Message when Missing Data

Therefore, please evaluate it in the stopped state of other applications or in the network/offline state. If data is still missing, reduce the number of configured channels.

The measurement times for the continuous measurement setup are shown below.

Table 1-8 SDADC24 Measurement Time when Setting up Continuous Measurement

| Items | Descriptions |
|------------------------|--|
| Measurement Time of | 5 minutes (fixed regardless of the number of channels and sampling |
| Continuous Measurement | mode setting) |



(b) Notes on SDADC24 8kHz/4kHz Hybrid sampling Mode measurement

When measuring in 8kHz/4kHz Hybrid sampling Mode, there will be a time difference between the measured values of 8kHz sampling data and 4kHz sampling data. This is due to the difference in delay time due to the difference in the circuit configuration of SDADC24.



Figure 1-3 Waveform Example of Time Difference between Measured Values of 8kHz Sampling Data and 4kHz Sampling Data during 8kHz/4kHz Hybrid Sampling

1.3 Precautions on Use

• Precaution on SDADC24

The measurement may not be performed properly during the sampling period immediately after start of the first measurement. Therefore, do not use the measurement data from the first measurement, but use the measurement data from the second measurement onwards.

1.4 Feature Updates History

The feature updates are as follows.

Table 1-9 Feature Updates History

| Items | Before Change (Rev.2.10) | After Change (Rev.2.30) |
|--------------------------------------|-------------------------------|----------------------------|
| UART I/F: | Frequency of PCLKB = PCLKD is | Frequency of PCLKB = PCLKD |
| ADC12 Continuous | 12MHz or 8MHz | of 32MHz or 24MHz |
| Measurement Conditions | | |
| FSP Version | v5.2.0 | v5.6.0 |



1.5 File Configurations

The following is a list of file configurations. The description of some folders and files is omitted.

| r01an7280xx0230-ra2a2-serial └──ek_ra2a2 | |
|---|--|
| └──ek ra2a2 uart0 32MHz | e2 studio project for SCI UART0 PCLKB 32MHz |
| | |
| | |
| │ │ | |
| ⊢_ra gen | |
| ⊢_script | |
| └──src | |
| hal_entry.c | |
| │ │ | |
| │ │ │ │ │ │ │ │ │ │ │ │ r_common_config.h | |
| │ │ ├──r_common_func.c | |
| │ │ | |
| │ │ | |
| │ │ | |
| │ │ | |
| │ │ | |
| r_reg_write.c | |
| r_reg_write_if.h | |
| | |
| | e2 studio project for SCI UART0 without RTS/CTS Flow Control PCLKB_32MHz re the same as the ek_ra2a2_uart0_32MHz, so they are omitted. |
| | |
| ← ek_ra2a2_uart0_24MHz | e2 studio project for SCI UAR IU PCLKB_24MHZ |
| I he folder structure and file structure a | re the same as the ek_ra2a2_uart0_32MHz, so they are omitted. |
| ek_ra2a2_uart3_32MHz | e2 studio project for SCI UART3 PCLKB_32MHz |
| The folder structure and file structure a | re the same as the ek_ra2a2_uart0_32MHz, so they are omitted. |
| | |
| Hex | |
| ∣ └──ek_ra2a2 | |
| ek_ra2a2_uart0_32MHz_rev230.hex | Hex file for UAR 10 PCLKB=PCLKD=32MHz |
| ek_ra2a2_uart0_16MHz_rev230.hex | Hex file for UAR IO PCLKB=PCLKD=16MHz |
| ek_ra2a2_uart0_24MHz_rev230.hex | Hex file for UARTO PCLKB=PCLKD=24MHz |
| ek_ra2a2_uart0_12MHz_rev230.hex | Hex file for UAR TO PCLKB=PCLKD=12MHz |
| ek_ra2a2_uart0notiow_32tviHz_rev230 | J. nex Hex file for UAR TO POLKB=POLKD=32/VIHZ without RTS/CTS Flow Control |
| ek_ra2a2_uart3_32IVITZ_rev230.nex | |
| | |
| r01an7280ej0230-ra2a2-serial.odf | |
| -ro1an7280jj0230-ra2a2-serial.pdf | |
| - <i>m</i> | |

Figure 1-4 File Configurations



1.6 Operation Confirmation Environment

This FW is confirmed under the operating conditions shown in Table 1-10 and Table 1-11.

The settings of the included HEX file are shown below.

Table 1-10 Operating Confirmation Conditions

| Items | Descriptions |
|-----------------------------|--|
| MCU | R7FA2A2AD3CFP (Renesas RA2A2 MCU Group) |
| | Supply voltage: 3.3V |
| IDE | Renesas e2 studio V2024-10 (24.10.0) |
| FSP | v5.6.0 |
| Tool Chain | GNU ARM Embedded 13.1.1.arm-13-7 |
| | Optimization Level: -Og |
| Emulator | SEGGER J-Link [®] |
| QE for AFE | V2.3.0 |
| FW Writing Tool | Renesas Flash Programmer V3.11.01 |
| USB-UART conversion adapter | Hi-Speed 12Mbps USB-UART conversion adapter: |
| | USB 2.0 Hi-Speed to UART Cable C232HD-EDHSP-0 |
| | 3Mbps USB-UART conversion adapter: |
| | PMOD I/F: PmodUSBUART |
| | mikroBUS I/F: USB UART click (MIKROE-1203) |
| FTDI Driver for PC | Virtual COM port (VCP) drivers V2.12.36.4 |
| | URL: VCP Drivers - FTDI (ftdichip.com) |

Table 1-11 Clock Settings and Tools to Use (SCI UART)

| Items | SCIUART | | | |
|--------------------------------|--|-------|----------------------|----------|
| Main Clock | HOCO | 64MHz | HOCO 48MHz | |
| ICLK | 321 | ЛНz | 48M | ИНz |
| PCLKB [Note 3] | 32MHz | 16MHz | 24MHz | 12MHz |
| PCLKD [Note 3] | 32MHz | 16MHz | 24MHz | 12MHz |
| FCLK | 321 | ЛНz | 24 | ИHz |
| SDADCCLK Clock Source | HOCO/4(=16MHz) HOCO/4(=12MHz) | | | (=12MHz) |
| USB-UART Conversion Adapter | Hi-Speed 12Mbps USB-UART conversion adapter: Available at 5.333333Mbps or less 3Mbps USB-UART conversion adapter: Available at 3Mbps or less The maximum bitrate for both depends on the PCLKB frequency [Note 3]. | | equency | |
| HEX File | Included [Note 1] | | | |
| e2 Project | Included [Note 2] | | Included [Note 2] | |

Note 1: Refer to 'Table 1-2 HEX Files'.

Note 2: Refer to 'Table 1-3 e2 studio Projects'.

Note 3: Use at maximum bitrate.

1.7 Related Documentation

- Renesas RA2A2 Group User's Manual: Hardware (R01UH1005)
- Renesas RA2A2 Group Evaluation Kit for RA2A2 Microcontroller Group EK-RA2A2 v1 User's Manual (R20UT5333)



2. How to Use

2.1 How to Write FW

There are two ways to write the FW to the EK-RA2A2.

- Writing HEX files using Renesas Flash Programmer
 - References to Connecting to PC: '2.1.1(1) EK-RA2A2 Writing Preparation'
 - References to Writing using Renesas Flash Programmer: '2.1.1(2) Launch the Renesas Flash Programmer and Communication Settings'
- Writing a project using the e2 studio integrated development environment (IDE)
 - References to Connecting to PC: '2.2.1 Connecting to PC'
 - References to Debugging operation: '3.4 Write and Build Using e2 studio Integrated Development Environment (IDE)'

2.1.1 Writing using Renesas Flash Programmer

You can write HEX files to RA2A2 on the EK-RA2A2 using Renesas Flash Programmer.

The operation procedure when using Renesas Flash Programmer V3.11.01 is shown below.

Get the Renesas Flash Programmer V3.11.01 or later that supports RA Family from the following.

https://www.renesas.com/software-tool/renesas-flash-programmer-programming-gui

(1) EK-RA2A2 Writing Preparation

1. Connecting to a PC

Use the on-board debug mode of the EK-RA2A2's USB debugging I/F.

By default, the jumper is enabled with the onboard debugger.

For details on how to set the jumper, refer to "5.2 Debugging" in the "RA2A2 MCU Group Evaluation Kit User's Manual".

The connection method is shown below.



Figure 2-1 How to Connect to PC when Writing HEX Files



(2) Launch the Renesas Flash Programmer and Communication Settings

The following two cases are described.

- Without a Renesas Flash Programmer project
- Renesas Flash Programmer Project has been Created

(a) If No Renesas Flash Programmer Project for RA Family Has Been Created

1. Create a New Project.

Click 'New Project ...' in 'File'. Set the 'Microcontroller' in 'Project Information' to "RA". Set the 'Tool' of 'Communication' to "J-Link" and 'Interface' to "2 wire UART". Click 'Connect'.

Renesas Flash Programmer starts the connection process. Confirm that the connection is successful.

| Create New Project | _ | | \times |
|---|------|--------|----------|
| Project Information | | | |
| Microcontroller: RA 🗸 | | | |
| Project Name: | | | |
| Project Folder: | | Browse | |
| Communication | _ | | |
| . Tool: J-Link 🗸 Interface: 2 wire UART 🗸 | ~ | | |
| Tool Details Num: AutoSelect | | | |
| | | 0 | |
| Con | nect | Cance | 81 |

Figure 2-2 Setting of 'Microcontroller', 'Tool' and 'Interface'

2. Set Communication Speed.

The communication speed is 9,600 bps. It can be set to 115,200 bps. If necessary, change it. Here's how to set it up:

Click on the 'Connections' tab. Set 'Speed' to "115,200".

| Renesas Flash Programmer V3.11.01 | - 🗆 🗙 |
|--|------------|
| File Target Device Help | |
| Operation Operation Settings Block Settings Connect Settings Unique Code | |
| Communication Tool J-Link V Interface: 2 wire UART V Speed: 111 Tool Details Num: AutoSelect | ,200 🗸 bps |
| Device Authentication Settings | |

Figure 2-3 Setting of Communication Speed 115,200 bps



(b) If Renesas Flash Programmer Project for RA Family Has Been Created

1. Open the project.

Click 'Open Project ...' in 'File' and select the project file. Click the 'Connection Settings' tab to check the communication speed. If you want to set the communication speed to 115,200 bps, refer to 'Figure 2-3 Setting of Communication Speed 115,200 bps'

(3) Writing to RA2A2

Write the FW according to the operating procedure of Renesas Flash Programmer.



2.2 Run Project

2.2.1 Connecting to PC

Debug USB I/F provides a power supply voltage for the EK-RA2A2. Refer to the 'EK-RA2A2 v1 User's Manua'.

The following shows the relationship between available USB-UART conversion adapters, connection methods, and corresponding e2 studio Project/HEX Files.

For details on the UART pin assignments, refer to 'Table 3-2 Pins used List'.

Table 2-1 Relationship between Available USB-UART Conversion Adapters, Connection Methods, and Corresponding e2 studio Project/HEX Files

| Connection I/F | USB 2.0 Hi-Speed to UART Cable | PmodUSBUART | USB UART click (MIKROE-1203) | e2 studio Project, HEX File |
|-------------------|-----------------------------------|-----------------------|---------------------------------|--|
| | C232HD-EDHSP-0 | | | |
| Arduino Uno | Refer to 'Arduino Uno | Refer to 'Arduino | | ek_ra2a2_uart0_32MHz project |
| I/F | I/F: Using Hi-Speed | <u>Uno I/F: Using</u> | | ek_ra2a2_uart0_24MHz project |
| [Note 1] | 12Mbps USB-UART | 3Mbps USB-UART | | • ek_ra2a2_uart0_32MHz_rev230.hex |
| | Conversion Adapter' | Conversion Adapter' | | • ek_ra2a2_uart0_24MHz_rev230.hex |
| | | | | • ek_ra2a2_uart0_16MHz_rev230.hex |
| | | | | • ek_ra2a2_uart0_12MHz_rev230.hex |
| mikroBUS I/F | | | Refer to 'mikroBUS | ek_ra2a2_uart0nohwflow_32MHz |
| [Note 1] | | | I/F: Using 3Mbps | project |
| | | | USB-UART | ek_ra2a2_uart0nohwflow_32MHz_r |
| | | | Conversion Adapter' | ev230.hex |
| PMOD2 I/F | | Refer to 'PMOD2 | | ek_ra2a2_uart3_32MHz project |
| | | I/F: Using 3Mbps | | • ek_ra2a2_uart3_32MHz_rev230.hex |
| | | USB-UART | | • ek_ra2a2_uart3_16MHz_rev230.hex |
| | | Conversion Adapter' | | |

Note 1: The SCI used is SCI0 for both. Therefore, connect a USB-UART conversion adapter to one of the connectors. Do not connect anything to the other connector.

A connection example is shown below.



(1) Arduino Uno I/F: Using Hi-Speed 12Mbps USB-UART Conversion Adapter

Connect the Arduino Uno connector to the USB 2.0 Hi-Speed to UART Cable C232HD-EDHSP-0.

The following shows how to connect the Arduino Uno pins and C232HD-EDHSP-0.

If you make a mistake in connection, the board and USB-UART conversion adapter may be damaged.

 Table 2-2 How to Connect Arduino Uno Connector and USB-UART Conversion Adapter

| EK-RA2A2 | | USB-UART Conversion | Adapter |
|-------------------------|--------------------|---------------------|------------------|
| Arduino Uno | Pin Assign | C232HD-EDHSP-0 | PmodUSBUART |
| Digital (J24 Connector) | | | |
| SCL | P411/SCL0 | | |
| SDA | P410/SDA0 | | |
| AREF | +3.3V | [Note 1] | #6: VCC [Note 2] |
| GND | GND | GND / BLACK | #5: GND |
| D13/SCK0 | P102/SCK0 | CTS# / BROWN | #4: CTS# |
| D12/MISO | P101/RXD0 | TXD / ORANGE | #3: TXD |
| D11/MOSI | P100/TXD0 | RXD0 / YELLOW | #2: RXD |
| D10/SS | P103/CTS0 [Note 3] | RTS# / GREEN | #1: RTS# |
| D9 | P105/GPIO | | |
| D8 | P303/GPIO | | |

Note 1: Do not connect the VCC of the USB-UART conversion adapter because there is a voltage difference between the board VDD and the USB-UART conversion adapter VCC. The same applies even if the VCC of the USB-UART conversion adapter is 3.3V.

Note 2: Set the jumper on PmodUSBUART to "LCL-VCC".

Note 3: The P103 is also wired to the PMOD1 #10 GPIO. When using PMOD1 at the same time, consider the circuit configuration to prevent malfunctions due to signals from PMOD1 #10 pin.

Below is a connection example when using USB 2.0 Hi-Speed to UART Cable C232HD-EDHSP-0.

Connect to Digital ~9, ~10, ~11, 12, 13, and GND.



Figure 2-4 Example of Connecting USB 2.0 Hi-Speed to UART Cable C232HD-EDHSP-0 to Arduino Uno Connector



(2) Arduino Uno I/F: Using 3Mbps USB-UART Conversion Adapter

Due to the circuit configuration of the EK-RA2A2 Arduino Uno I/F, PmodUSBUART can be directly inserted.

For information on how to connect the Arduino Uno pins and PmodUSBUART, refer to 'Table 2-2 How to Connect Arduino Uno Connector and USB-UART Conversion Adapter'.

Also, there is no need to supply voltage from the VCC of PmodUSBUART to EK-RA2A2. Therefore, set the jumper on PmodUSBUART to "LCL-VCC".

If you make a mistake in connection, the board and USB-UART conversion adapter may be damaged.

Below is a connection example when using PmodUSBUART.

Connect to Digital ~9, ~10, ~11, 12, 13, GND and AREF.



Figure 2-5 Example of Connecting PmodUSBUART to Arduino Uno Connector



(3) mikroBUS I/F: Using 3Mbps USB-UART Conversion Adapter

Due to the EK-RA2A2 circuit, RTS/CTS flow control is not possible. Therefore, FW performs 2-wire control using only TXD/RXD. For more information, refer to 'Table 3-2' Pins used List'.

Below is a connection example when using USB UART click (MIKROE-1203).



Figure 2-6 Example of Connecting USB UART Click (MIKROE-1203) to mikroBUS Connecter

(4) PMOD2 I/F: Using 3Mbps USB-UART Conversion Adapter

The default circuit of the PMOD2 connector part of EK-RA2A2 is the circuit setting for Type-6A. Therefore, it is necessary to change to a Type-3A circuit. Please refer to the EK-RA2A2 user's manual (R20UT5333) for how to change.

Also, there is no need to supply voltage from the VCC of PmodUSBUART to EK-RA2A2. Therefore, set the jumper on PmodUSBUART to "LCL-VCC".

Below is a connection example when using PmodUSBUART.



Figure 2-7 Example of Connecting PmodUSBUART to PMOD2 Connector



2.2.2 Launch QE for AFE

'QE for AFE' has a "Plugin version" that works in the e2 studio environment and a "Standalone version".

Here, the procedure for measuring using the "Standalone version" is shown.

For details on the operation of 'QE for AFE', refer to the 'QE for AFE' Help.

2.2.2.1 Preparation

Prepare the following in advance.

1. Writing FW

Refer to '2.1 How to Write FW'.

2. Connection between PC and EK-RA2A2

Refer to '2.2.1 Connecting to PC'.

2.2.2.2 Launching QE for AFE and Connecting to Target Board

Follow the steps below to connect to the target board.

- 1. Launching QE for AFE
- 2. Importing Configuration [Note] File if Configuration file Has Been Prepared

If there is already a set file, the imported set value during the connection process with the target boat will be written.

3. Connection with Target Board

Check the COM number of USB-UART Conversion Adapter in the PC device manager and select the COM number from 'COM Port:'.

| Bitrate | | |
|----------|---------|--|
| 100000 | × | |
| | Set | |
| COM Port | | |
| сом | ~ | |
| | Connect | |

Figure 2-8 Selecting COM Number

Also, check the following display on the console.

[Info]Connect succeeds.

Figure 2-9 Message on Console when Connection is Successful

If it has been imported, the setting value will be written subsequently. The following is displayed on the console.

[Info]Write \$\$\$ register value to the target board successfully.

Figure 2-10 Message on Console when Connection is Successful (\$\$\$: IP Name)



2.2.2.3 Message at Time of Completion of QE for AFE Continuous Measurement and Measurement Time

QE for AFE has an upper limit on the number of acquired data.

Depending on the IP used, the message when the upper limit is reached will differ.

(1) SDADC24

When setting Continuous measurement, the number setting of channels is set and the sampling mode setting are independent, and data for 5 minutes can be acquired.

The message when the limit is reached is as follows:

[Error]The reserved buffer is full. Tuning is forced to stop.

Figure 2-11 Message when Maximum Number of Acquired Data is Reached in Case of SDADC24

(2) ADC12

The continuous measurement time depends on the setting of ADSSTRn.

For the approximate time to output the message during ADC12 continuous measurements, refer to 'Table 1-5 ADC12 Continuous Measurement Operation Conditions when Using SCI UART'

The message when the limit is reached is as follows:

[Error]The reserved buffer is full. Tuning is forced to stop. If longer tuning time is required, please increase the average number or the over sampling ratio.

Figure 2-12 Message when Maximum Number of Acquired Data is Reached in Case of ADC12



3. Program Description

3.1 Overview

This FW supports the Command/Response method communication.

The UART communication with 'QE for AFE' via SCI UART of EK-RA2A2. Then A/D measurement and Comparison measurement are executed according to the Command Request from 'QE for AFE'.

3.2 Peripherals to Use and Pin Settings

3.2.1 Peripherals to Use

The following shows the list of peripherals used in this FW, and the settings for each peripheral function are shown below.

Table 3-1 Peripheral Features List

| Project | Intended Use |
|---------|--|
| SDADC24 | A/D measurement |
| ADC12 | A/D measurement |
| SCIn | Communication: Used of UART SCI communication: |
| | When using, connect USB-UART conversion adapter. |
| | Refer to 'Table 1-10 Operating Confirmation Conditions'. |
| DTC | Used for SCI0 UART communication and data acquisition from the following registers |
| | ADC12 A/D data registers y(ADDRy) |
| | ADC12 A/D Temperature Sensor Data Register (ADTSDR) |
| | ADC12 A/D Internal Reference Voltage Data Register (ADOCDR) |
| | SDADC24 Sigma-Delta A/D Conversion Result Register Type 1(SDADCRn) |
| | • SDADC24 Sigma-Delta A/D Conversion Result Register (LPF) Type 1(SDADCRLPFn) |
| | SDADC24 Sigma-Delta A/D Conversion Result Register Type 2(SDADCRmT2) |
| | SDADC24 Sigma-Delta A/D Conversion Result Register (LPF) Type |
| | 2(SDADCRLPFmT2) |



3.2.2 Pin Settings

3.2.2.1 Pin List

The following is a list of pins used in this FW.

The blue text indicates the functions set by this FW.

Table 3-2 Pins used List

| No | Pin | Configuration Function | Content |
|----|------|----------------------------|-----------------------|
| 1 | P015 | AN003/EXLVDBAT | Used as an analog pin |
| 2 | P403 | GTIOC48/MISO0 | |
| 3 | P404 | MOSI0 | |
| 4 | P405 | RSPCK0 | |
| 5 | P400 | IRQ9/RTCIC0 | |
| 6 | P401 | IRQ10/RTCIC1 | |
| 7 | P402 | RTCOUT/IRQ11/RTCIC2 | [Note 2] |
| 8 | VRTC | VRTC | |
| 9 | P215 | VCIN | |
| 10 | P214 | XCOUT | |
| 11 | VSS | VSS | |
| 12 | VCL | VCL | |
| 13 | P213 | XTAL | |
| 14 | P212 | EXTAL | |
| 15 | VCC | VCC | |
| 16 | P211 | EXLVD | |
| 17 | P210 | GTIOC5B/CLKOUT/ADTRG0/IRQ8 | |
| 18 | RES | RES | |
| 19 | P201 | MD | |
| 20 | P200 | NMI | |
| 21 | P600 | - | |
| 22 | P408 | GTIOC9A/SSLA0 | |
| 23 | P409 | GTIOC9B/SSLA1 | |
| 24 | P410 | GTIOC6A/SDA00 | |
| 25 | P411 | GTIOC7A/SCL0 | |
| 26 | P300 | GTIOC6B/SWCLK/SWCLK | |
| 27 | P108 | SWDIO/SWDIO/DTOC7B/RTCOUT | |
| 28 | P209 | САРН | |
| 29 | P208 | CAPL | |
| 30 | VL1 | - | |
| 31 | VL2 | - | |
| 32 | VL4 | - | |
| 33 | P207 | VL3 | |
| 34 | P206 | COM0 | |
| 35 | P205 | COM1 | |
| 36 | P204 | COM2 | |
| 37 | P203 | СОМЗ | |
| 38 | P301 | SEG0/COM4 | |
| 39 | P302 | SEG1/COM5 | |
| 40 | P303 | SEG2/COM6 | |
| 41 | P304 | SEG3/COM7 | |
| 42 | P305 | SEG4 | |



| 43 | P306 | SEG5/IRQ0 | |
|----|--------|-------------------------------------|----------------------------|
| 44 | P307 | SEG6/IRQ1 | |
| 45 | P308 | IRQ2/SEG7 | |
| 46 | P309 | IRQ3/SEG8 | For LED1 control (Red LED) |
| 47 | P310 | IRQ4/SEG9 | |
| 48 | P311 | IRQ5/SEG10 | |
| 49 | P312 | SEG11/IRQ6 | |
| 50 | P313 | SEG12/IRQ7 | [Note 2] |
| 51 | P100 | AGTOA0/AGTOB0/AGTO0/TXD0 | TXD0 pin for SCI0 UART |
| | | /GTIOC8A/AGTEE0/SEG13 | [Note 1 2] |
| 52 | P101 | AGTOA1/AGTWO0/AGTOB1/RXD0 | RXD0 pin for SCI0 UART |
| 02 | | /AGTO1/GTIV/GTI0C8B/AGTEE1/SEG14 | [Note 1 2] |
| | | | |
| 53 | P102 | AGTOA2/AGTOB2/AGTO2/GTIOC6A/GTIW | RTS pin for SCI0 UART |
| | | /ADTRG0/AGTWEE0/AGTEE2/SEG15/SCK0 | [Note 1,2] |
| 54 | P103 | AGTOA3/GTOUUP/AGTOB3/CTS_RTS0/AGTO3 | CTS pin for SCI0 UART |
| | | /GTIOC6B/SSLA3/AGTWIO0/SEG16/AGTEE3 | [Note 1,2] |
| 55 | P109 | AGTOA4/AGTOB4/SEG17/AGTWOB0 | |
| | | /GTOULO/AGTO4/CLKOUT/TXD9/AGTEE4 | |
| 56 | P110 | AGTOA5/AGTOB5/RXD9/SEG18/GTOVUP | |
| | | /AGTWOA0/AGTO5/AGTEE5 | |
| 57 | P111 | GTOVLO/SEG19/AGTOB6/AGTOA6/AGTO6 | |
| | | /GTIO5A/AGTEE6/SCK9 | |
| 58 | P112 | AGTOB7/AGTOA7/CTS_RTS9/GTIOC5B | |
| | | /GTOWUP/AGT07/SSLA2/SEG20/AGTEE7 | |
| 59 | P113 | SEG21 | |
| 60 | P114 | SEG22 | |
| 61 | P115 | SEG23 | |
| 62 | VCC | VCC | |
| 63 | VSS | VSS | |
| 64 | P104 | SEG24/GTIOC8A/SCK2 | |
| 65 | P105 | CTS_RTS2/SEG25/GTIOC8B | |
| 66 | P106 | TXD2/SEG26 | |
| 67 | P107 | RXD2/SSLA1/SEG27 | |
| 68 | P500 | RXD3/IRQ4/SEG28 | TXD3 pin for SCI3 UART |
| | | /AGTIO0/GTOWLO/AGTWEE1 | [Note 3] |
| 69 | P501 | GTETRGA/SEG29/AGTIO1/AGTWIO1 | RXD3 pin for SCI3 UART |
| | | /TXD3/IRQ5 | [Note 3] |
| 70 | P502 | | RTS pin for SCI3 UART |
| 10 | 1 002 | /SEG30/AGTIO2/IRO6/SCK3 | |
| 74 | DEOO | | |
| 71 | P503 | GTIOC9B/CTS_RTS3/AGTWOA1/AGTIO3 | CTS pin for SCI3 UART |
| 70 | DE0.4 | /SSLAU/SEG31/IRQ7 | |
| 72 | P504 | | |
| 13 | P505 | | |
| 74 | P010 | | |
| 75 | P013 | | |
| 76 | P012 | | |
| // | P011 | | |
| 78 | | | |
| /9 | | | |
| 00 | AININD | AININO | Used as an analog pini |



| 81 | ANIP5 | ANIP5 | Used as an analog pin |
|-----|-------|--------------|------------------------|
| 82 | ANIN5 | ANIN5 | Used as an analog pinl |
| 83 | ANIP4 | ANIP4 | Used as an analog pin |
| 84 | ANIN4 | ANIN4 | Used as an analog pinl |
| 85 | ANIP3 | ANIP3 | Used as an analog pin |
| 86 | ANIN3 | ANIN3 | Used as an analog pinl |
| 87 | ANIP2 | ANIP2 | Used as an analog pin |
| 88 | ANIN2 | ANIN2 | Used as an analog pinl |
| 89 | ANIP1 | ANIP1 | Used as an analog pin |
| 90 | ANIN1 | ANIN1 | Used as an analog pinl |
| 91 | ANIP0 | ANIP0 | Used as an analog pin |
| 92 | ANIN0 | ANINO | Used as an analog pinl |
| 93 | AVRT | AVRT | |
| 94 | AVCM | AVCM | |
| 95 | AREGC | AREGC | |
| 96 | AVSS | AVSS | |
| 97 | AVCC | AVCC | |
| 98 | P002 | AN002/VREFL0 | Used as an analog pin |
| 99 | P001 | AN001/VREFH0 | Used as an analog pin |
| 100 | P014 | AN000 | Used as an analog pinl |

Note 1: This is used for TXD/RXD 4-wire control with RTS/CTS flow using the Arduino Uno connector. On the Arduino Uno connector, these four pins are placed side by side.

The projects that make use of these pins are shown in 'Table 1-3 e2 studio Projects'.

ek_ra2a2_uart0_32MHz

ek_ra2a2_uart0_24MHz

Note 2: This is used for TXD/RXD 2-wire control using the mikroBUS connector.

The projects that make use of these pins are shown in 'Table 1-3 e2 studio Projects'.

ek_ra2a2_uart0nohwflow_32MHz

Due to the circuit of the EK-RA2A2, hardware CTS flow control of the SCI UART is not possible, so no RTS/CTS flow control is realized by the following connection.

— g_uart0 UART (r_sci_uart) [Settings]:

Common -> Flow Control Support: Disabled (Default)

Module g_uart0 UART -> Flow Control:

CTS/RTS Selection: Hardware RTS (Default) Software RTS Port: Disabled (Default) Software RTS Pin: Disabled (Default)

Pins -> CTS_RTS: None

— Pin Selection (SCI0) [Pin Configuration]:

Name -> Operation Mode: Asynchronous UART

Name -> Input/Output -> CTS_RTS0: None (Disable P103.)

| Settings | Property | Value |
|----------|-----------------------------|---------------|
| API Info | ✓ Common | |
| | Parameter Checking | Default (BSP) |
| | FIFO Support | Disable |
| | DTC Support | Enable |
| | Flow Control Support | Disable |
| | RS-485 Support | Disable |
| | IrDA Support | Disabled |
| | ✓ Module g_uart0 UART (r_sc | i_i |
| | > General | |
| | > Baud | |
| | ✓ Flow Control | |
| | CTS/RTS Selection | Hardware RTS |
| | Software RTS Port | Disabled |
| | Software RTS Pin | Disabled |
| | > Extra | |
| | > Interrupts | |
| | ✓ Pins | |
| | CTS_RTS0 | None |
| | RXD0 | P101 |
| | TXDO | P100 |

| Pin Selection 📄 🗎 🗐 | ↓ <mark>a</mark> | Pin Configuration | |
|---|------------------|---------------------|-------------------|
| Type filter text | | Name | Value |
| > 🗸 Analog:ADC | ^ | Pin Group Selection | Mixed |
| > ✓ Analog:SDADC24 | | Operation Mode | Asynchronous UART |
| > CLKOUT:CLKOUT > ✓ Connectivity:IIC | | ✓ Input/Output | |
| | | CTS_RTS0 | None |
| | | RXD0 | ✓ P101 |
| Connectivity:SCI | | - | None |
| ✓ SCI0 | | TXD0 | ✓ P100 |
| SCI1 | | | |



- mikroBUS I/F: Pin Selection [Pin Configuration]
 mikroBUS RST (P313): Connected to FTDI FT232RL CTS#
 - Name -> Mode: GPIO Output mode (Initial Low) (Default)
 - mikroBUS INT (P402): Connected to FTDI FT232RL RTS#
 - Name -> Mode: Disabled (Disabled IRQ function)

| | | | | Pin Selection $\blacksquare \blacksquare \blacksquare \downarrow_{\mathbf{Z}}^{\mathbf{a}}$ | Pin Configuration | |
|---|--|-------------------|---------------------------|---|-------------------|--------------|
| F | Pin Selection $\exists \exists \exists \exists \exists \exists a \\ \exists \exists z \end{bmatrix}$ | Pin Configuration | | Type filter text | Name | Value |
| | Type filter text | Name | Value | V V Ports | Symbolic Name | MIKROBUS_INT |
| | ., per little text | Symbolic Name | MIKROBUS RST | PO | Comment | |
| | ✓ P307 ^ | Comment | | > • P1 | Mode | Disabled |
| | ✓ P308 ✓ P309 ✓ P310 P311 | Mode | Output mode (Initial Low) | > ¥ P2 | IRQ | None |
| | | Pull up/down | None | > v P3 | Output Type | CMOS |
| | | IRO | None | ✓ ✓ P4 | ✓ Input/Output | |
| | | Output Type | CMOS | ✓ P400 | P402 | None |
| | P312 | s Input/Output | cinos | ✓ P401 | | |
| | ✓ P313 ✓ P4 | P313 | SPIO | P402 | | |

 — EK-RA2A2 Ø P102, P103 for SCI0: Pin Selection [Pin Configuration] 102 (Simple SPI SCK0): No connection on mikroBUS Name -> Mode: Disabled

P103 (CTS_RTS0): No connection on mikroBUS Name -> Mode: GPIO Output mode (Initial Low)



Note 3: This is used for TXD/RXD 4-wire control with RTS/CTS flow using the PMOD2 connector. The projects that make use of these pins are shown in 'Table 1-3 e2 studio Projects'. ek_ra2a2_uart3_32MHz

3.2.3 How LED Work

LED3 (Red LED) on the EK-RA2A2 lights up during the following operations.

- During A/D conversion operation of SDADC24 or ADC12



3.3 Communication Specifications

The communication specifications for 'QE for AFE' and FW are as follows.

3.3.1 UART Serial Communication Settings

The serial communication settings for UART SCI communication are as follows.

When measuring SDADC24, set the maximum transfer rate of the USB-UART conversion adapter.

In the following cases, change the bitrate setting of QE for AFE back to 1M bps.

— When the EK-RA2A2 is reset

| Items | Settings |
|--------------------------|---|
| Transfer Speed (Bitrate) | Default: 1M bps (Lower Limit) |
| | Maximum: 3M bps [Note 1] / 4M bps [Note 4] / 5.333333M bps [Note 5] |
| | The bitrate (over 1Mbps) can be changed after the initial communication. |
| | The bitrate that has been confirmed to work are shown below. If you set the bitrate other than the following, normal communication may not be possible. |
| | — 5.333333M bps [Note 5] |
| | — 4M bps [Note 4] |
| | — 3M bps |
| | — 2.666666M bps [Note 3] |
| | — 2M bps |
| | — 1.5M bps |
| | — 1M bps |
| Data Length | 8-bit |
| Parity | No parity |
| Stop Bit | 1-bit |
| Hardware Flow Control | CTS pin: Set to CTS function enabled (RTS function disabled) |
| [Note 2] | RTS pin: Port control |

Note 1: This value is when using a 3Mbps USB-UART conversion adapter.

Note 2: Refer to 'Table 3-2 Pins used List'. Depending on the project, the pins are different.

RTS/CTS flow control is standard. Depending on the project, RTS/CTS flow control may not be available.

Note 3: PCLKB frequency = 16MHz, Hi-Speed 12Mbps USB-UART conversion adapter can be used.

Note 4: PCLKB frequency = 24MHz, Hi-Speed 12Mbps USB-UART conversion adapter can be used.

Note 5: PCLKB frequency = 32MHz, Hi-Speed 12Mbps USB-UART conversion adapter can be used.



3.4 Write and Build Using e2 studio Integrated Development Environment (IDE)

Import the project, build the project, and write to RA2A2 on the EK-RA2A2. For the included projects, refer to 'Table 1-3 e2 studio Project'.

3.4.1 Import Procedure

The import procedure is shown in the figure below.



Figure 3-1 Steps to Import a Project into e2 studio

3.4.2 Launch Debug Mode

Execute the 'Build' and press . Then the 'Debug' mode will be executed automatically.



3.4.3 Notes on Building e2 Studio Projects

The build execution results in a warning.

- p_data:
- avcc0_range:

This argument is used when setting the low voltage on other MCU boards that can set the low voltage. It doesn't be used in this project. Therefore, ignore it.

```
../src/r_reg_write.c: In function 'QE4AFE_RegWrite':
../src/r_reg_write.c:1569:102: warning: unused parameter 'avcc0_range' [-Wunused-parameter]
1569 | fsp_err_t QE4AFE_RegWrite(uint32_t * p_wr_adrs, uint32_t wr_data, uint8_t write_access_size, uint8_t avcc0_range)
```



3.4.4 Stack Size

The stack size is set as follows.

Table 3-4 Stack Size Setting

| Project | Stack Size |
|------------------------|------------|
| SCI UART communication | 0x600 |



3.4.5 About e2 studio Project Source Changes

In FSP Configuration, only the clock setting is allowed to be changed.

Therefore, select the project on which you want to base your changes. For details on setting up a project, '1.1.1(2)e2 studio Projects'.

Follow the steps below to display the 'Clocks Configuration'.

[Project Explorer] -> [configuration.xml] file -> Click [Clocks] tab]

Figure 3-3 shows Clock setting changes.

It is possible to change the clock setting in the FSP environment shown in 'Table 1-10 Operating Confirmation Conditions'.

It is also possible to change the clock setting of SDADCCLK.

For details on clock settings, refer to User's Manual: Hardware.

For the clocks and their frequencies that are allowed to change, Renesas recommend setting of the clocks and their frequencies shown in 'Table 1-11 Clock Settings and Tools to Use (SCI UART)'.

During continuous measurement operation, if the clock frequency is lowered, it may not be possible to measure normally. Therefore, please evaluate it sufficiently.

For clock settings during continuous measurement operation, refer to 'Table 1-5 ADC12 Continuous Measurement Operation Conditions when Using SCI UART' and 'Table 1-7 SDADC24: Sampling Mode, Number of Channels and Supported Bitrate when Using UART'.

| [ek_ra2a2_uart0_32MHz_rev210alpha6] FSP Configuratio | n 🗙 🔂 startup.c | | |
|--|---|--|---|
| Clocks Configuration | | | Generate Project Content |
| XTAL 20MHz LOCO 32768Hz MOCO 8MHz HOCO 64MHz SUBCLK 32768Hz PLL Src: Disabled PLL Div /2 PLL Div /2 PLL Mul x781 | → Clock Src: HOCO CLKOUT Disabled SDADCCLK Src: HOC | <pre>ICLK Div /2 PCLKB Div /2 PCLKD Div /2 PCLKD Div /2 CLKOUT Div /1 CO ∨→ SDADCCLK 16MHz</pre> | Restore Default \checkmark ICLK 32MHz \checkmark PCLKB 32MHz \checkmark PCLKD 32MHz \checkmark CLKOUT 0Hz |

Figure 3-3 FSP Configuration Clock Setting Screen when using UART I/F



4. Trouble-solving Method

The trouble cases are shown below. Please refer to it when evaluating.

| 1 | RFP: Unable to connect to board after writing with Renesas Flash Programmer. | | | | |
|---|---|--|--|--|--|
| | For boards that require jumper settings when writing: Not applicable for EK-RA2A2 | | | | |
| | You must restore the jumper settings that you set for writing to their original state. | | | | |
| | Check the jumper settings. | | | | |
| 2 | GUI: When using UART I/F: Cannot connect to the board. | | | | |
| | There may be a bit rate mismatch. Follow the steps below. | | | | |
| | (1) Reset the board. | | | | |
| | (2) Set the Bitrate of 'QE for AFE' [ConnectSetting] to 1M bps. | | | | |
| | ConnectSetting × | | | | |
| | Bitrate setting (bps) | | | | |
| | OK Cancel | | | | |
| | (3) Connect to the board using 'OE for AEE' | | | | |
| | | | | | |
| | Note: Since it is necessary to change the bit rate during continuous measurement of | | | | |
| | ADC16/12, it is necessary to set the bitrate of 'QE for AFE' to 1M bps if the board reset is | | | | |
| | executed. | | | | |
| | You may set the bitrate that does not work and performed board connection processing. Follow the steps below. | | | | |
| | (1) Reset the board. | | | | |
| | (2) Set the Bitrate of 'QE for AFE' [ConnectSetting] to 1M bps. | | | | |
| | ConnectSetting × | | | | |
| | Bitrate setting 1000000 v (bps) | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | OK Cancel | | | | |
| | (3) Connect to the board using 'QE for AFE'. | | | | |
| | (4) Set the bitrate to the different value and try changing the bitrate. | | | | |
| | | | | | |
| | Note: If the bit rate is set to a large value, communication may not be possible. | | | | |



| 3 | • | GUI: QE for AFE drawing stops during Continuous measurement. | | | | |
|---|---|---|--|--|--|--|
| | | The following are the causes of drawing stoppage. | | | | |
| | | The measurement was automatically stopped because the upper limit of the number of data acquired by QE for AFE was exceeded. | | | | |
| | | For measurable time, refer to '2.2.2.3 Message at Time of Completion of QE for AFE Continuous Measurement and Measurement Time'. | | | | |
| | | Since the FTDI driver is old, data was missed on the PC and drawing stopped. | | | | |
| | | Please install the version shown in '1.6 Operation Confirmation Environment' or later on your PC. | | | | |
| | | • During continuous measurement, FW became unable to transmit data or QE for AFE stopped drawing due to variations in data acquisition timing on the PC USB side. | | | | |
| | | As a result of signal analysis with PC USB, it has been confirmed that data communication may rarely be performed for a period longer than the data transmission interval. In order to avoid the period when the | | | | |
| | | PC is not communicating, we recommend that you do not run other PC applications as much as possible and evaluate in the offline state. Still, the data missing may occur. Refer to '1.2.1(1)(a) ADC12 Continuous Measurement' | | | | |
| | | Also, if drawing is stopped due to this cause, the LED may be lit. In that case, stop tuning QE for AFE and check that the LED is off. If the LED is lit, reset the board and try connecting again. | | | | |
| 4 | • | GUI: QE for AFE drawing stops during One-shot measurement. | | | | |
| | | The following are the causes of drawing stoppage. | | | | |
| | | • The measurement was automatically stopped because the upper limit of the number of data acquired by QE for AFE was exceeded. | | | | |
| | | For measurable time, refer to '1.2.1(1)(b) ADC12 One-Shot Measurement'. | | | | |
| 5 | ٠ | GUI: Graph of QE for AFE is not drawn when measuring ADC16/12 or SDADC24. | | | | |
| | | It is possible that the Time Width setting is not appropriate. Check the following. | | | | |
| | | (1) If the Time Width(ms) is larger than the initial value of 100ms, set it to " 100m s". | | | | |
| | | ✓ Parameters | | | | |
| | | | | | | |
| | | SPS - | | | | |
| | | X-Axis | | | | |
| | | Time Top(ms) 0 Time Width(ms) 100 | | | | |
| | | In the case of SDADC24, it is possible that the Bitrate is a small value. | | | | |
| | | Make sure to set the Bitrate to a large value. | | | | |
| 6 | ٠ | GUI: Clicking 'Stop AFE monitoring' does not stop it. | | | | |
| | | This may occur if the FW cannot accept the STOP command during continuous measurement at a high | | | | |
| | | data rate. In that case, the following message will be displayed. Please follow the message. | | | | |
| | | [Error]STOP command failed to execute. Please try to press [Stop AFE monitoring] button again. | | | | |
| | | in cuning still can not stop, please reset the board and re-connect. | | | | |
| 7 | ٠ | GUI: Re-Clicking 'Start AFE monitoring' does not start it. | | | | |
| | | Even if you run it again, you may see the same message below. | | | | |
| | | In this case, "Disconnect" \rightarrow "Connect" again. If the reconnection is successful, the Bitrate setting remains | | | | |
| | | [Error]RUN command failed to execute. Please try again. | | | | |
| 8 | ٠ | GUI: Writes by register settings are not successful. | | | | |
| | | When writing the register settings, a normal response may not be displayed. | | | | |
| | | Communication did not end normally and has not been written. | | | | |
| | | To restore communication, change the settings and write the values. After that, you may be able to write the value you want to set again. | | | | |
| | | | | | | |



Revision History

| | | Descript | Description | | |
|------|-----------|----------|---|--|--|
| Rev. | Date | Page | Summary | | |
| 2.10 | Mar.14.24 | - | First Release | | |
| 2.30 | Jan.20.25 | - | FW updated. | | |
| | | | Added ADC12 Continuous measurement features at sampling | | |
| | | | time 5us. | | |



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.)

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a systemevaluation test for the given product.

Notice

- Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
- Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
- 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
- 5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
- 6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.

Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.

- 7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
- 8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
- 9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
- 10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
- 11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
- 12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
- This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
 Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas
- Electronics products. (Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries
- (Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.5.0-1 October 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan

www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: <u>www.renesas.com/contact/</u>.